

# ATLAS pixel detector

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on behalf of the ATLAS Collaboration

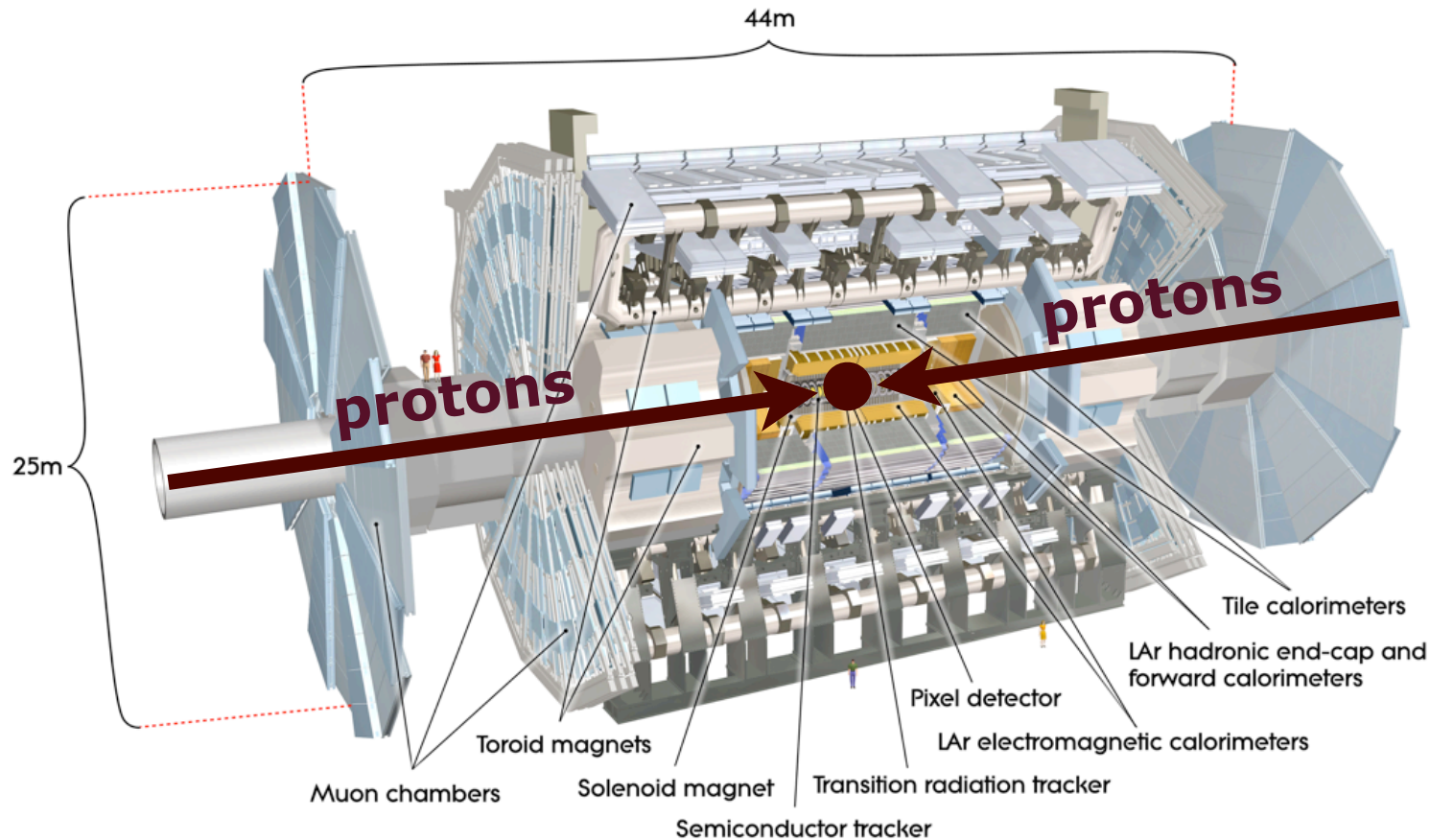
## Outline:

- Introduction
- Operation
- Calibration
- Performance
- Upgrade
- Summary



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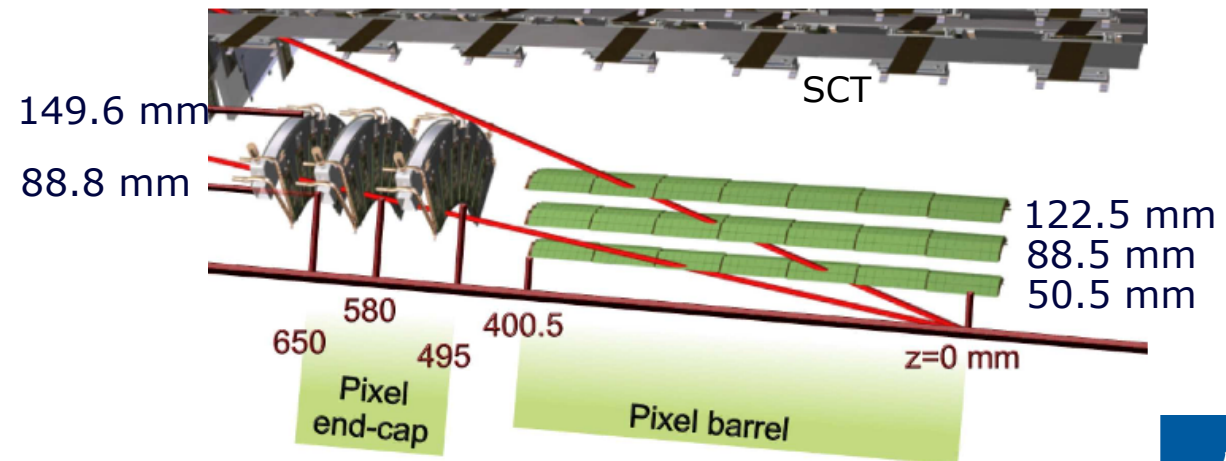
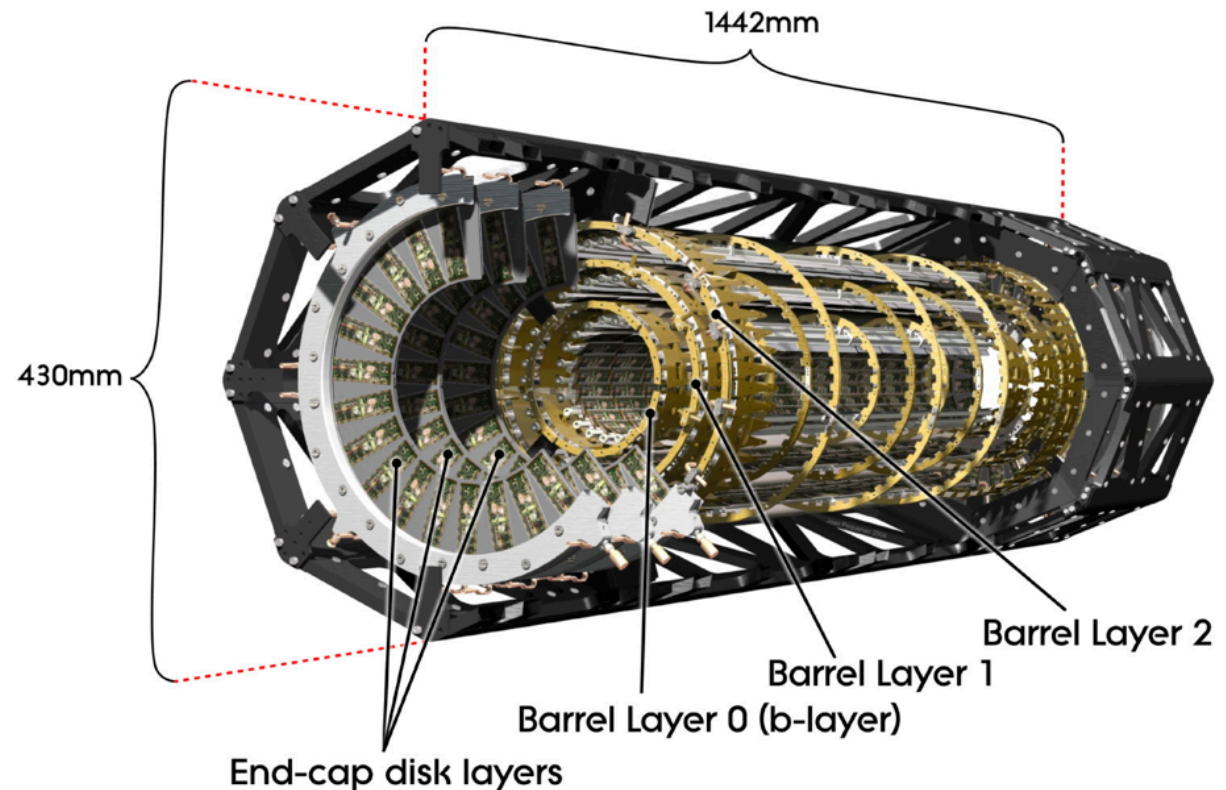
# ATLAS experiment



- Primary goals include discovery of the Higgs boson and potential extensions to the SM involving evidence of new physics.
- At design, 14 TeV LHC collisions providing 22 events per 25 ns at luminosity of  $10^{34} \text{ cm}^{-2}\text{s}^{-1}$ . In 2010, 45  $\text{pb}^{-1}$  of data at 7 TeV and peak luminosity of  $2 \times 10^{32} \text{ cm}^{-2}\text{s}^{-1}$ .

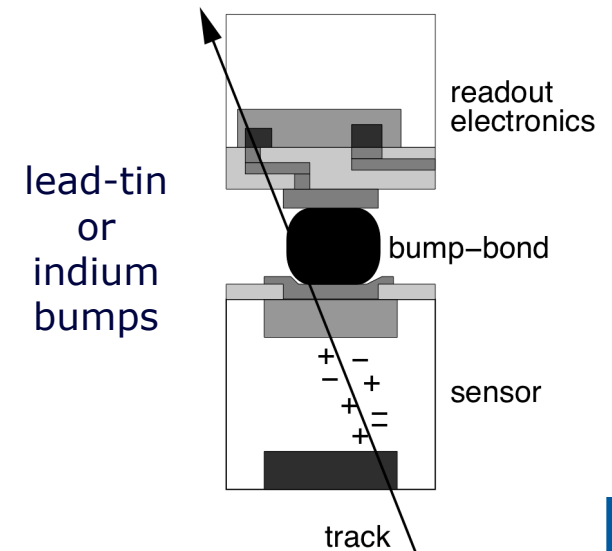
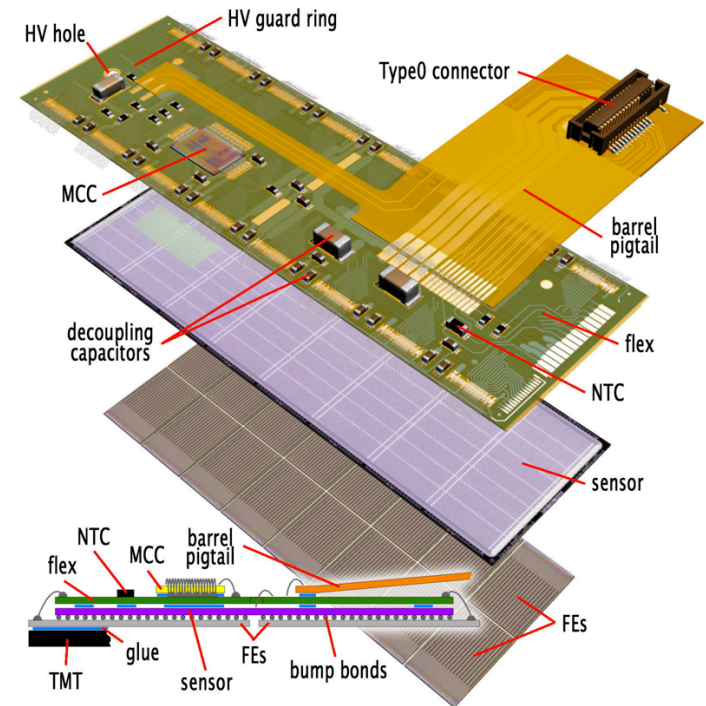
# Pixel detector

- 2 T magnetic field.
- 1456 modules in three layers of barrel region. 288 modules in three layers of end-cap regions.
- Barrel modules tilted by  $20^\circ$  in  $R\phi$  plane against the Lorentz angle to reduce occupancy.
- 80 million channels.
- $10\ \mu\text{m}$  resolution in  $R\phi$  and  $110\ \mu\text{m}$  in  $z$ .
- Modules operating at  $-15\ ^\circ\text{C}$  temperature.



# Pixel module

- 250  $\mu\text{m}$  thick silicon sensor with an active area of  $16.4 \times 60.8 \text{ mm}^2$ .
- 16 front-ends (FEs) per module bump bonded to the sensor.
- Radiation hard up to NIEL  $10^{15} \text{ 1 MeV n}_{\text{eq}}/\text{cm}^2$  and 30 MRad.
- 47232 pixels per module. Most with size  $50 \times 400 \mu\text{m}^2$ . Special pixels (long and ganged) to cover regions between FEs.
- Module controller chip (MCC) to send trigger, commands and configuration data, and to perform event building.
- 2x80 Mbps readout in b-layer (innermost), 80 Mbps in layer 1 and disks, and 40 Mbps in layer 2.





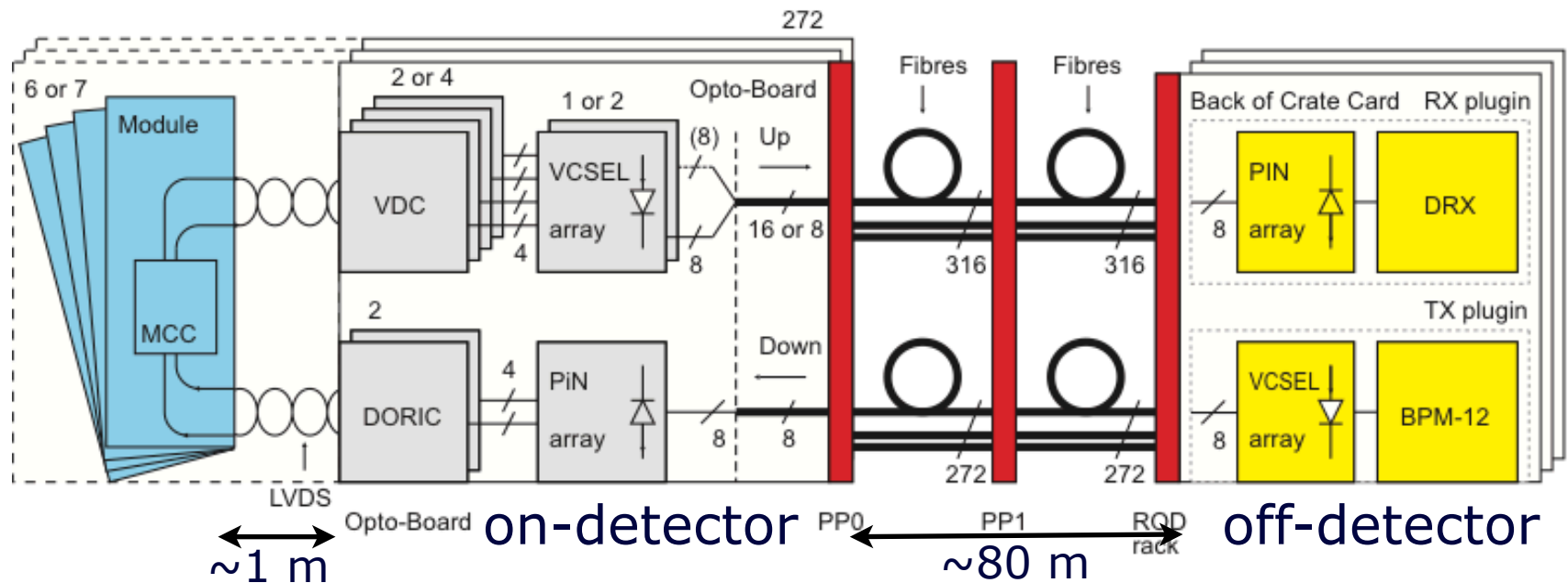
# Pixel operation

- 97.3% of pixel detector **operational**. 47/1744 (2.7%) modules and 44/27904 (0.16%) FEs are disabled.
- For pixel safety, high voltage (HV) is not turned on until LHC declares **STABLE BEAMS**.
- Preamplifiers are also off before switching on HV to avoid excessive noise which can block data acquisition (DAQ).
- Once stable beams declared, apply **WARM START** procedure which includes checking background rates in beam conditions monitor (BCM) and collimator positions, ramping up the HV and switching on preamplifiers.
- Pixel **data taking efficiency** is 99%. Loss dominated by warm start procedure.
- Automatic disable of modules blocking DAQ.

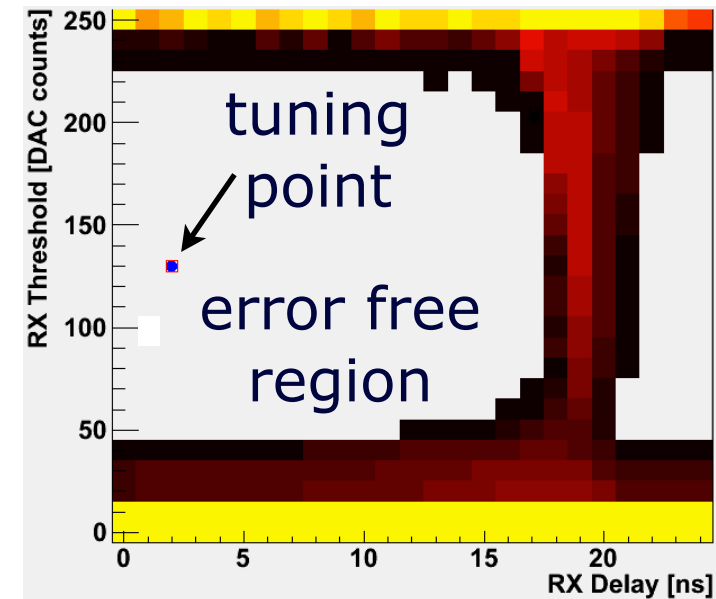
Inner Tracking Detectors			Calorimeters				Muon Detectors			
Pixel	SCT	TRT	LAr EM	LAr HAD	LAr FWD	Tile	MDT	RPC	CSC	TGC
99.0	99.9	100	90.5	96.6	97.8	94.3	99.9	99.8	96.2	99.8

Luminosity weighted relative detector uptime and good quality data delivery during 2010 stable beams in pp collisions at  $\sqrt{s}=7$  TeV between March 30<sup>th</sup> and October 31<sup>st</sup> (in %). The inefficiencies in the calorimeters will largely be recovered in a future data reprocessing.

# Optolink calibration

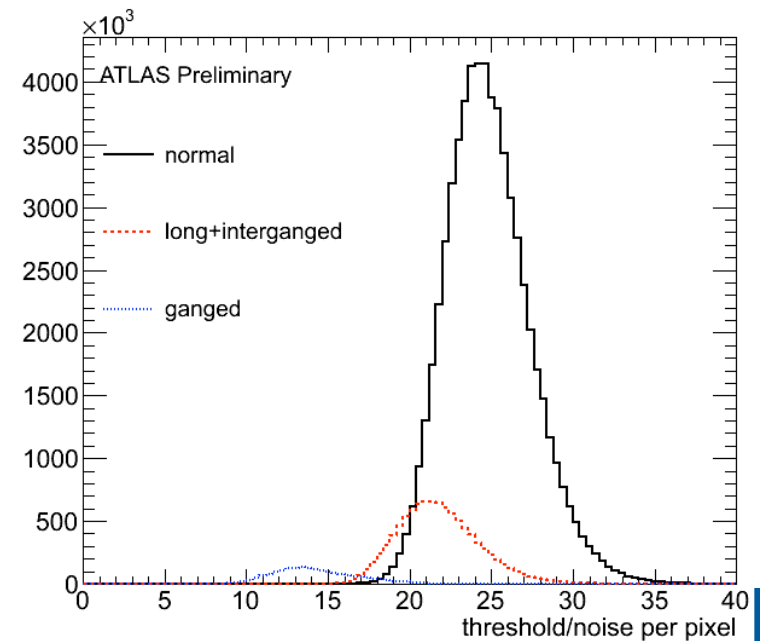
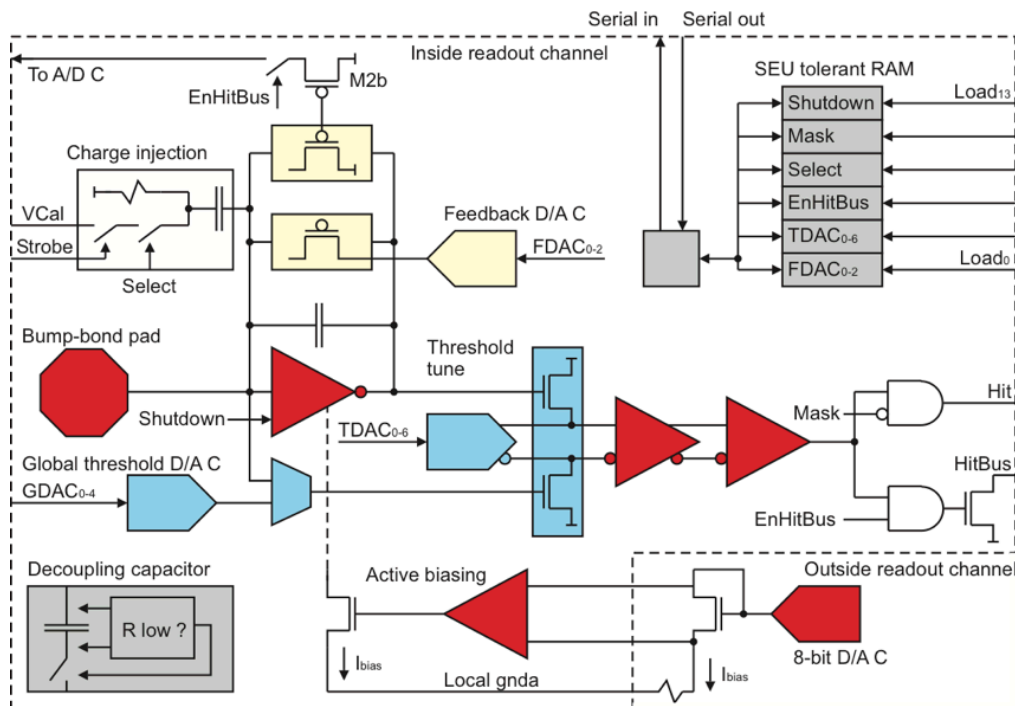
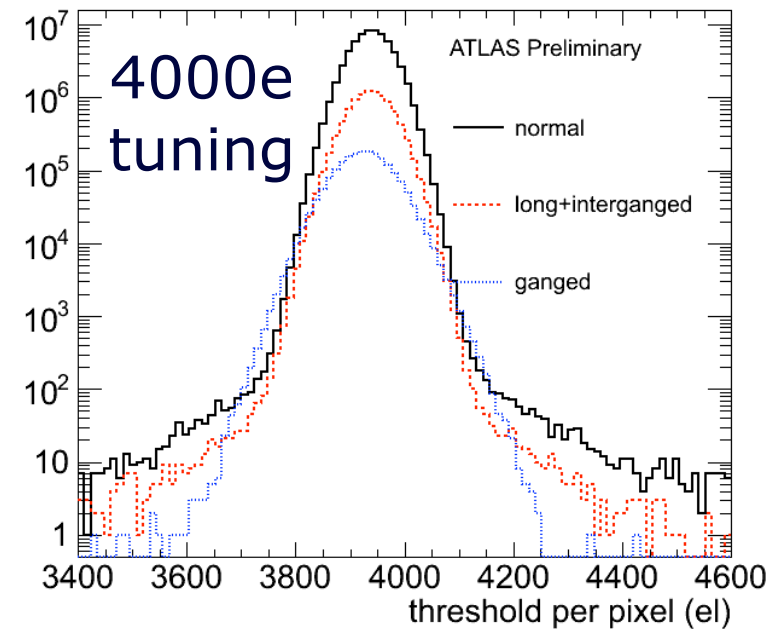


- On-detector laser power, and off-detector sampling threshold and phase are tuned to settings that avoid data readout errors.
- Boundaries between error-free regions (EFR) and error regions are not equally stable, so optimal operating point not in the centre of EFR.



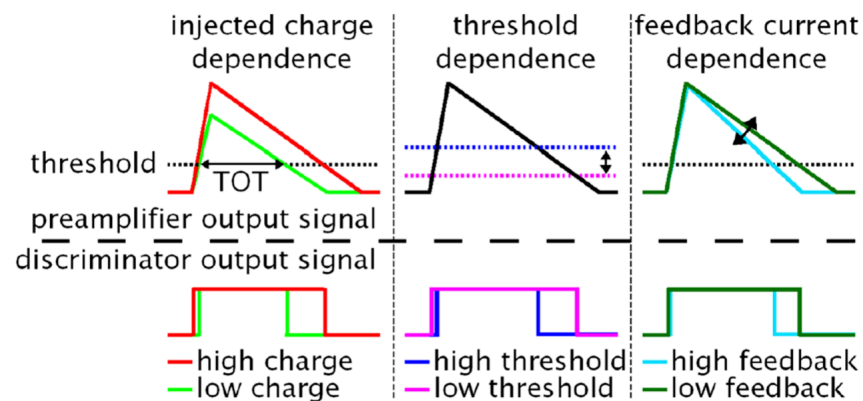
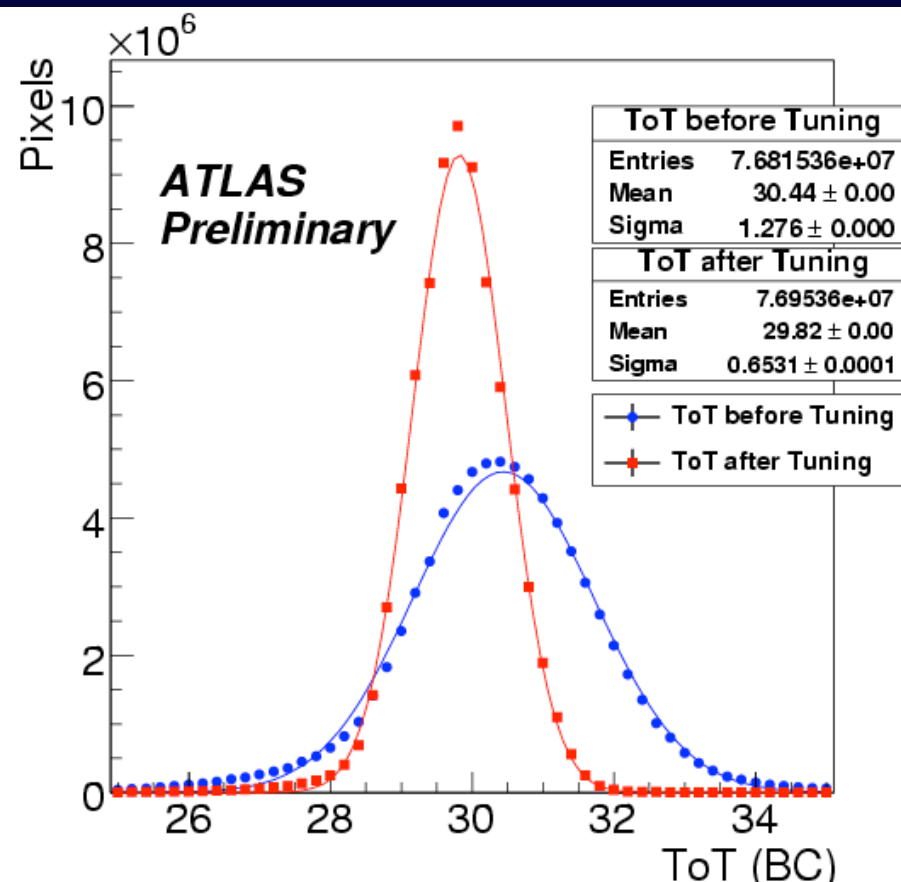
# Threshold calibration

- Inject # of test charges at target threshold, vary 7-bit DAC per pixel and count generated hits. Optimal value is at 50% efficiency.
- For 2010 collisions, threshold tuned to 3500e. Dispersion is about 40e.
- 0.1% of noisy pixels are masked.



# ToT calibration

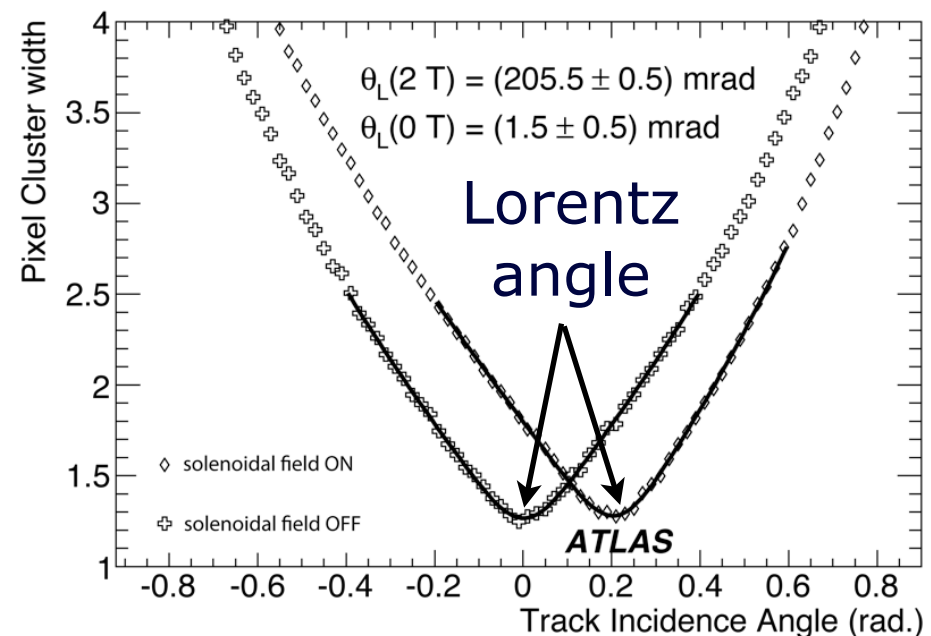
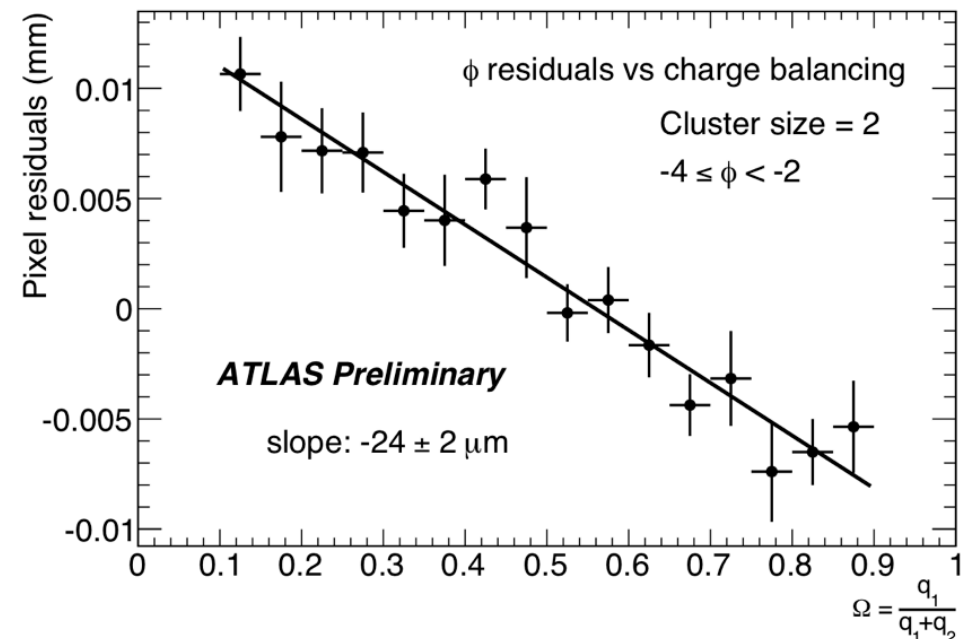
- **Time over threshold (ToT)** is the time in which signal is above threshold. In units of bunch crossings (BCs), i.e. 25 ns.  
$$\text{ToT} = p_0(p_1+Q)/(p_2+Q).$$
- Tuning target is **30 BCs for a charge of 20ke** (most probable for m.i.p.). **Resolution  $\sim 1$  BC.**
- Inject # of test charges at 20ke, vary 3-bit DAC per pixel to find optimal point resulting closest to target ToT.
- Low charge hits may end-up in the next BC due to slow rise above threshold. Compensated by copying to previous BC.





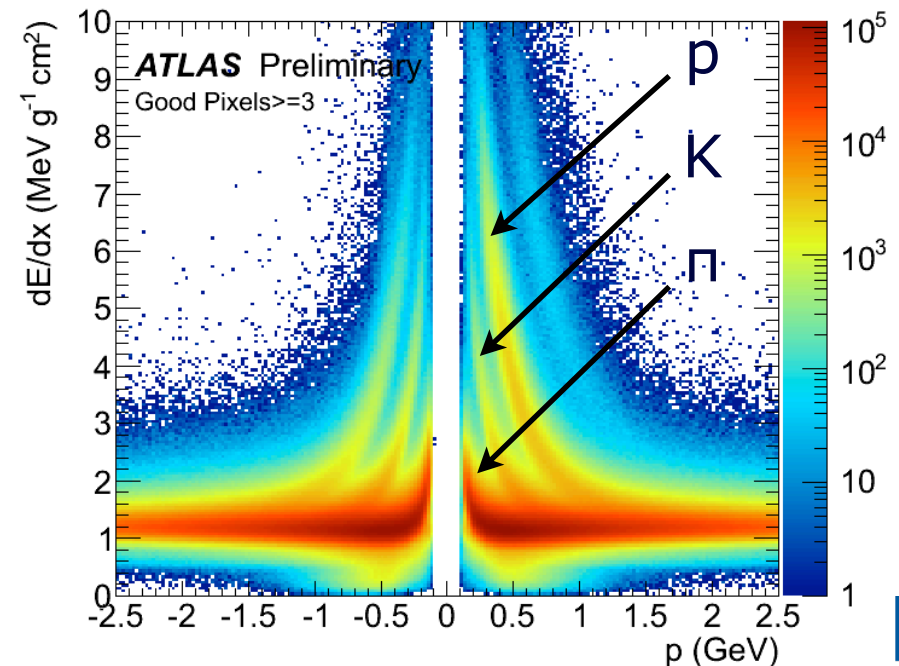
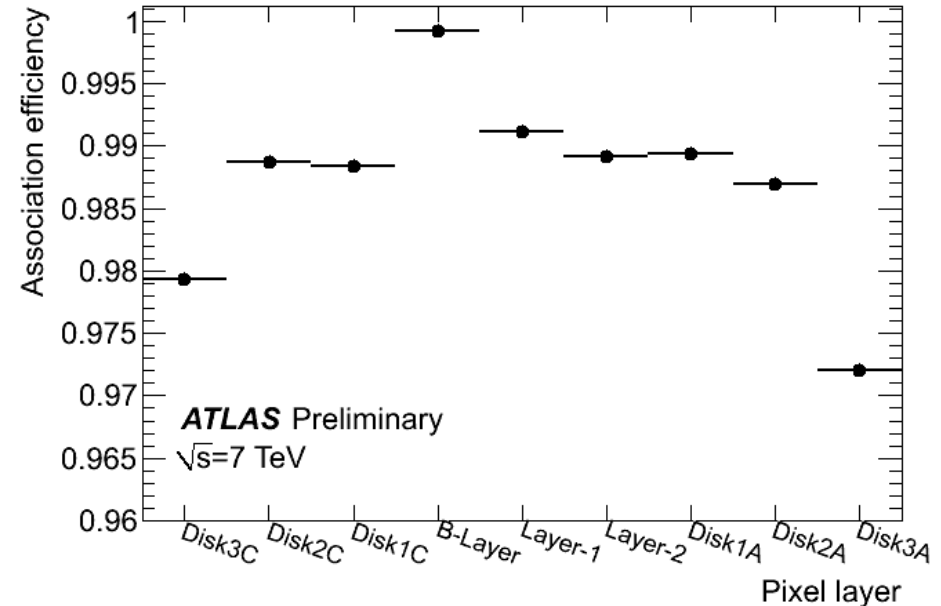
# Charge sharing and Lorentz angle

- Position residuals of pixels in a cluster depend on relative charge sharing between the pixels.
- Cluster position is calculated using charge weighted position of contributing pixels.
- **Lorentz angle** corresponds to track incident angle resulting in min cluster size.  
 $12.11 \pm 0.09^\circ$  for collisions.
- In a magnetic field, charge carriers drift at an angle w.r.t the normal of electrode surface. Displacement is about  $30 \mu\text{m}$ .



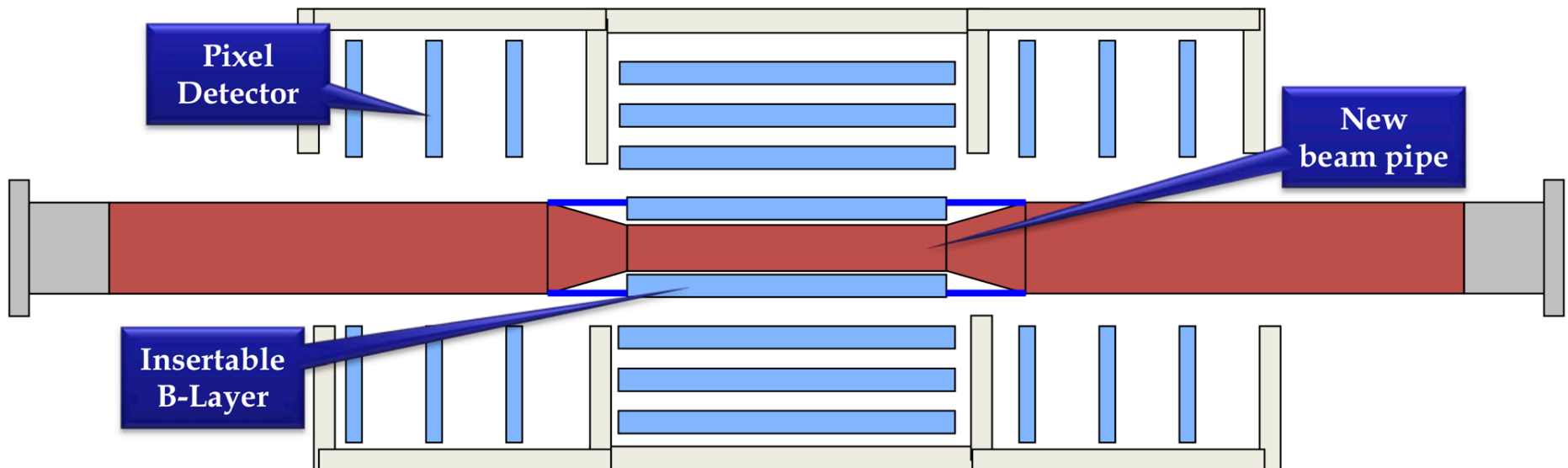
# Hit to track association and particle-id

- **Efficiency** of a track having **hits** for pixel detector layers crossed is about **99%**. Dead modules excluded.
- Full efficiency in b-layer due to track selection.
- Association inefficiency mostly due to known dead regions (pixels and or FEs) in modules.
- Charged particles with  $m \gg m_e$  traversing material loses energy mostly via ionization and excitation, described by Bethe-Bloch formula.
- Energy loss proportional to collected charge.



# Pixel upgrade (I)

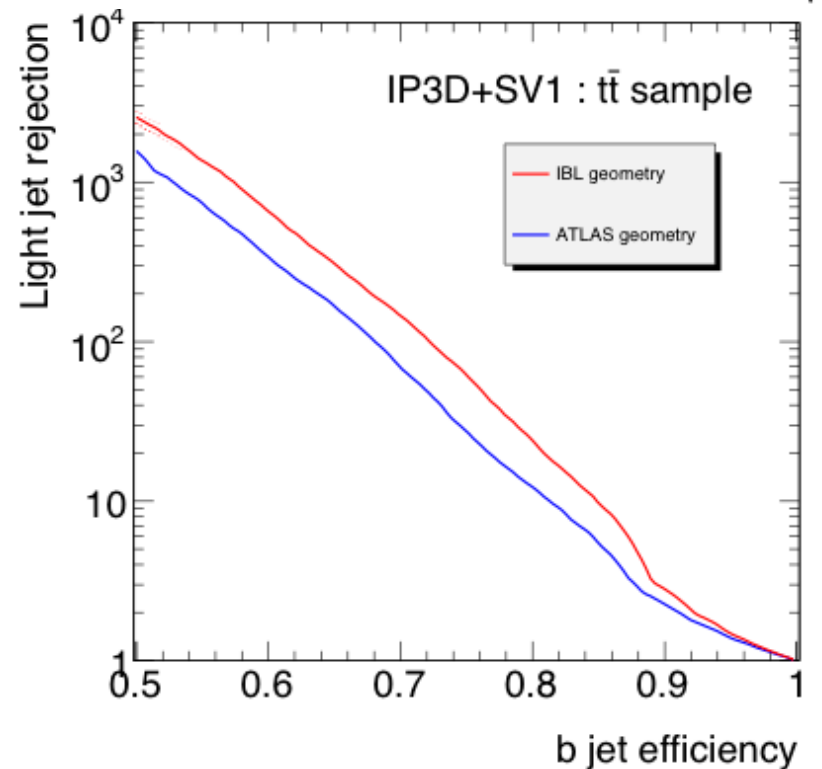
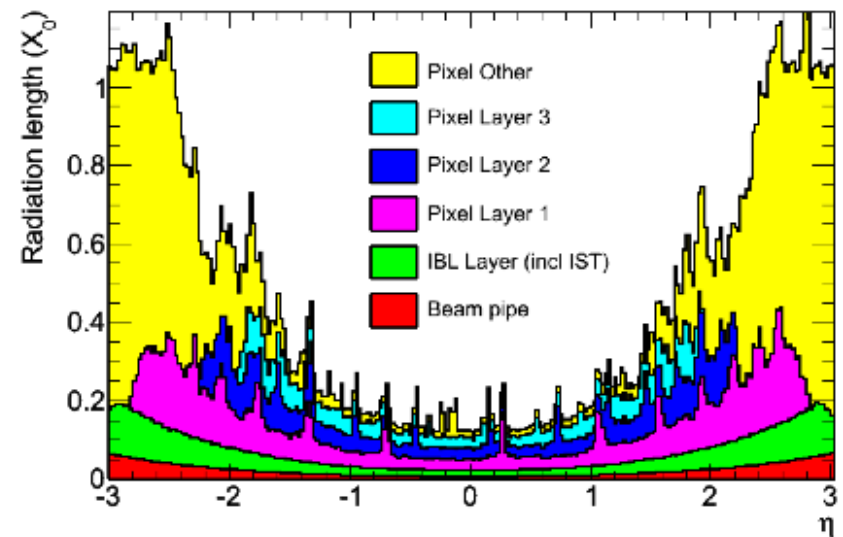
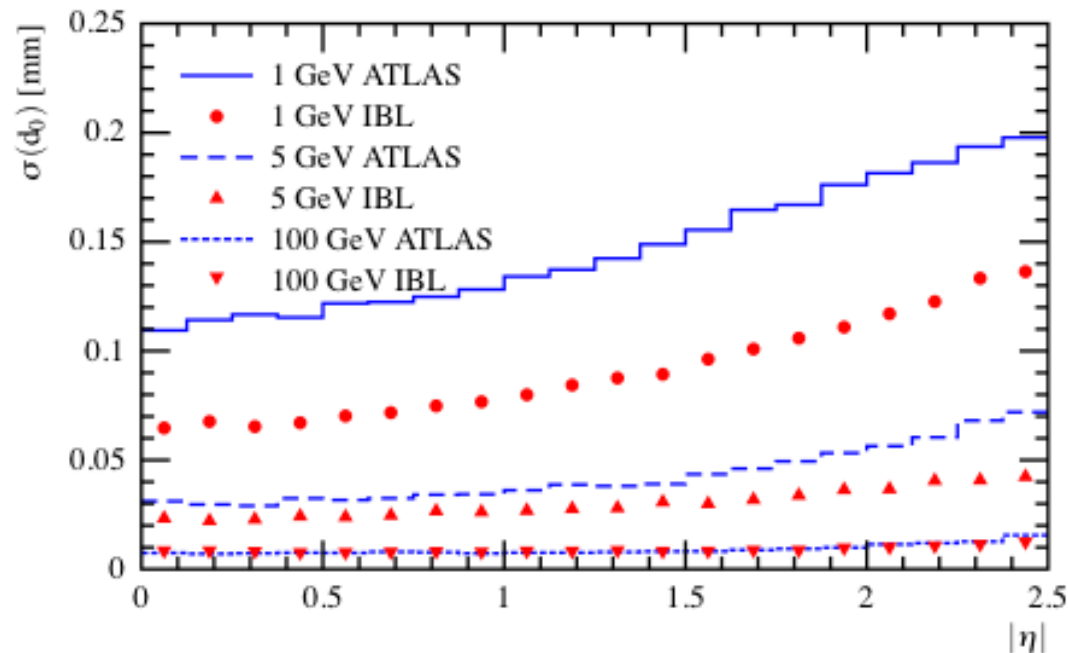
- LHC plans to reach peak luminosity of  $2 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$  by **2016**. Expected NIEL  $3 \times 10^{15} \text{ 1 MeV n}_{\text{eq}}/\text{cm}^2$ .
- **Additional insertable b-layer** (IBL) to be placed **at radius 3.2 cm** inside the current b-layer. Requires new narrower beam pipe.
- New technologies including FE-I4 (larger chip, smaller pixel size, storage of hits until trigger arrives and lower power), 3D silicon or CVD diamond sensors and  $\text{CO}_2$  cooling. Radiation hard up to NIEL  $5 \times 10^{15} \text{ 1 MeV n}_{\text{eq}}/\text{cm}^2$  and 250 MRad.



Fabian Huegging (ATL-UPGRADE-SLIDE-2010-260)

# Pixel upgrade (II)

- Placement of IBL at smaller radius combined with low density of material results in improved impact parameter resolution and vertex reconstruction.
- Higher track reconstruction efficiency.
- Increased b-tagging efficiency.



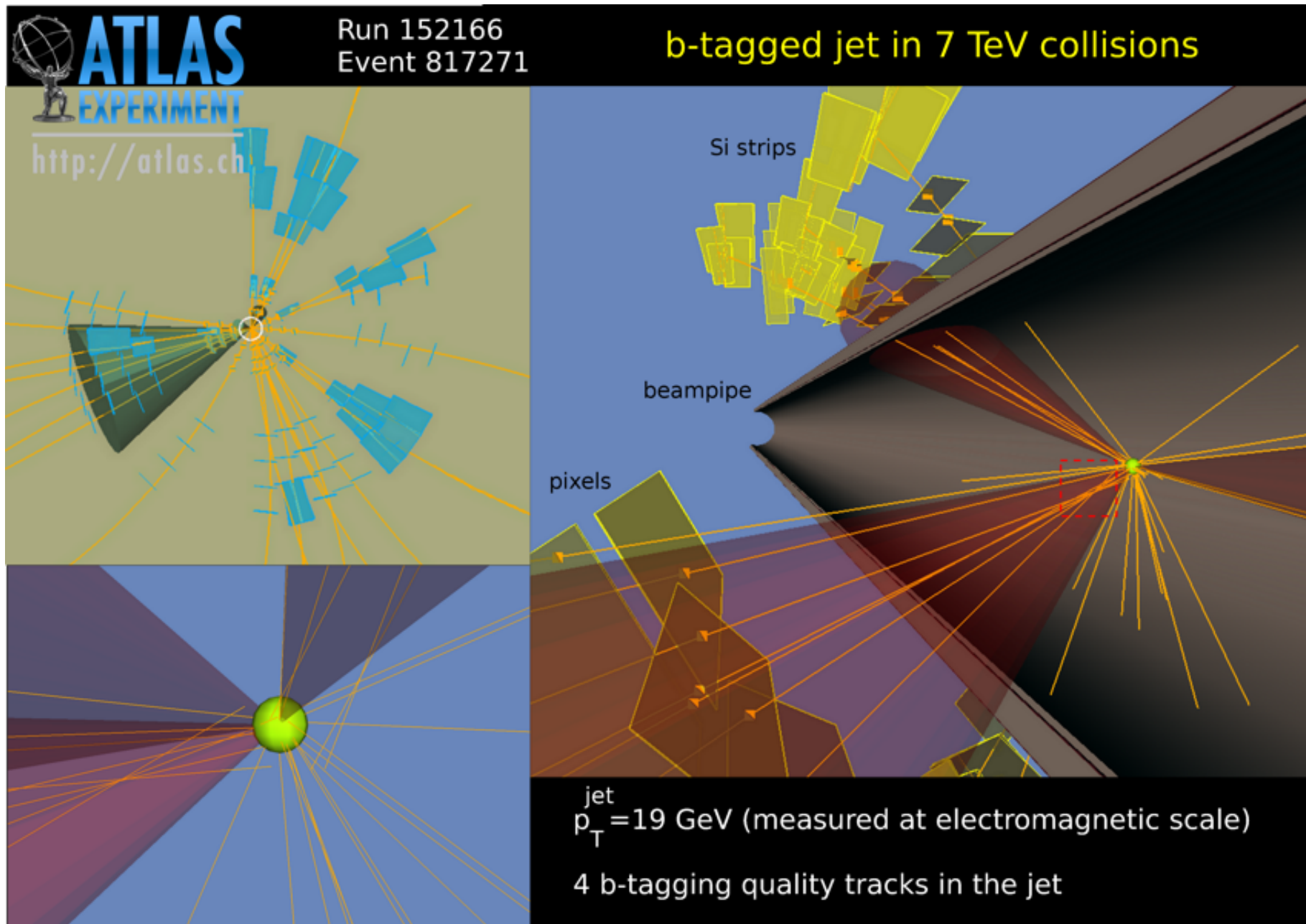
# Summary

- The ATLAS pixel detector is calibrated and performing well. Regular checks of performance and re-tuning when necessary.
- 97.3% of the pixel detector is operational.
- Position resolution 10  $\mu\text{m}$  in  $R\phi$  and 110  $\mu\text{m}$  in  $z$ .
- Pixel data taking efficiency is 99%.
- Pixel hit to track association efficiency is 99%.
- Upgrade with additional b-layer to be placed at radius 3.2 cm to improve performance and maintain performance of the pixel detector when existing b-layer degrades.

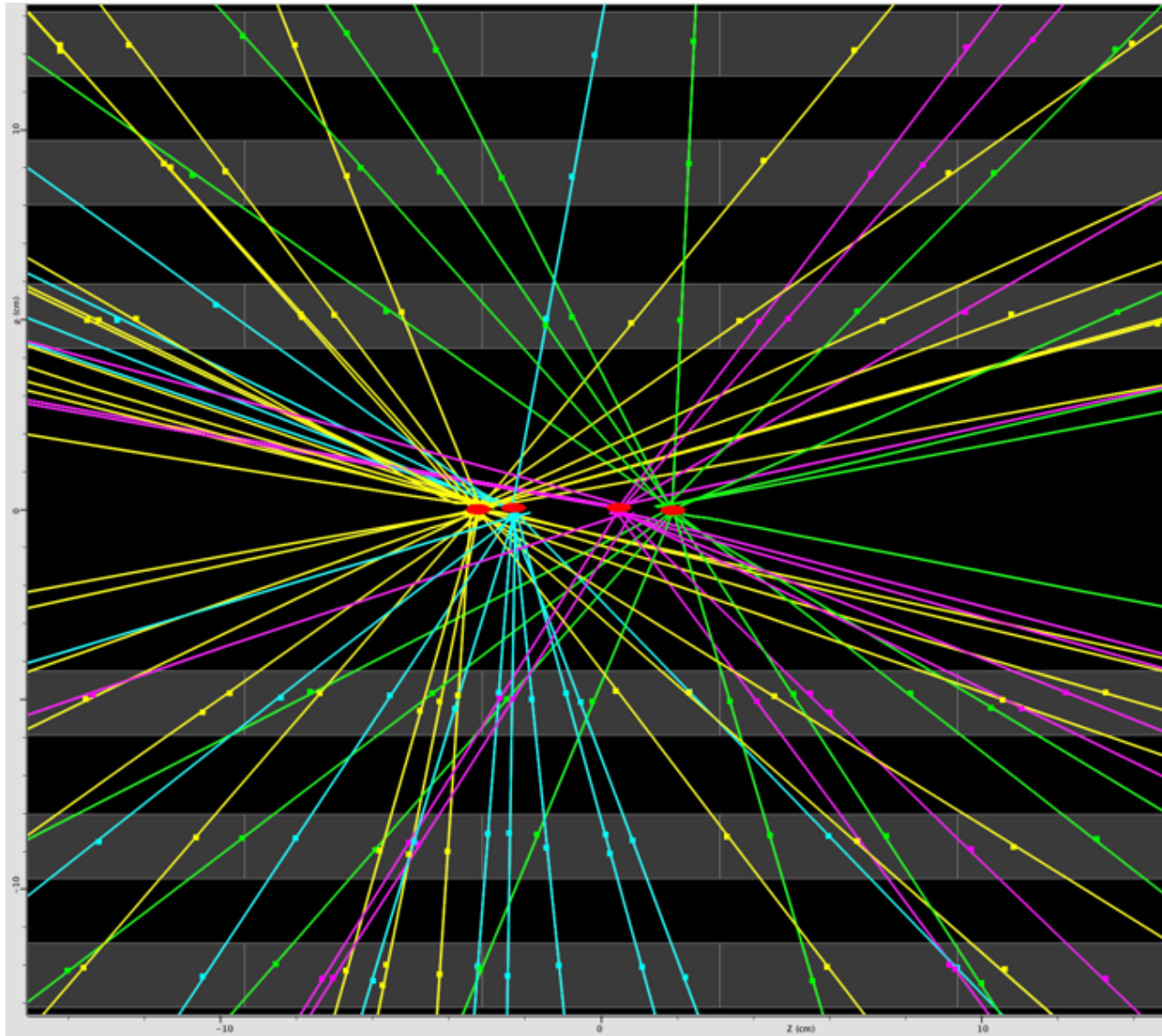


# Questions

# b-tagged jet



# Pileup event with four vertices



Run Number: 153565, Event Number: 4487360

Date: 2010-04-24 04:18:53 CEST

**Event with 4 Pileup Vertices  
in 7 TeV Collisions**

